

S-Band, GaN/SiC, RF Power Transistor

3.1 - 3.5 GHz \mid 300 W typ \mid 55% Efficiency typ \mid 13dB Gain typ \mid 50 V \mid 100 μ s Pulse Length, 10% Duty Cycle

IGN3135M250 and IGN3135M250S are high power GaN-on-SiC RF power transistors that have been designed for S Band radar systems. They supply a minimum of 250W of peak output power, with typically >13dB of gain and 55% efficiency. They operate from a 50 V supply voltage. For optimal thermal efficiency, the transistors are housed in a metal-based package with an epoxy-sealed ceramic lid.

FEATURES

- GaN on SiC HEMT Technology
- Output Power >250W
- Pre-Matched input and output impedance
- High Efficiency 55% typical
- 100% RF Tested under 100μs, 10% duty cycle pulse conditions
- RoHS and REACH Compliant



APPLICATIONS

S-band Radar Systems

Table 1. Absolute Maximum Ratings (Not Simultaneous)

Parameter	Symbol	Value	Units	Test Conditions
DC Drain-Source Voltage	$V_{\scriptscriptstyle DS}$	100	V	25 °C
DC Gate-Source Voltage	V _{GS}	-8 to +1.5	V	25 °C
DC Drain Current	I _D	24	A	25 °C
DC Gate Current	I _G	24	mA	25 °C
RF Input Power	P _{REIN}	20	W	25 °C
Operating Junction Temperature	T _j	-55 to +200	°C	
Storage Temperature	T _{stg}	-55 to +150	°C	
Soldering Temperature	T _{SOLDER}	260 for 10s	°C	

Note: Operation outside the limits given in this table may cause permanent damage to the transistor

Table 2. DC Electrical Characteristics (Case temperature = 25 °C unless otherwise stated)

Parameter	Symbol	Min	Тур	Max	Units	Test Conditions
Gate Pinch-Off Voltage	V _P	-4.0	-3.0	-2.5	V	$V_{DS} = 50V, I_{DS} = 2mA$
Quiescent Gate Voltage	V _Q		-2.8		V	$V_{DS} = 50V, I_{DS} = 100mA$



Table 3. RF Electrical Characteristics (Case temperature = 30 °C unless otherwise stated)

Parameter	Symbol	Min	Тур	Max	Units	Test Conditions
RF Output Power	P _{out, RF}	250	270	300	W	
Gain	G	11.9	12.3	13.0	dB	$P_{IN} = 16W$ f = 3.1, 3.3, 3.5 GHz 100 μ s pulse length, 10% duty cycle $V_{DS} = 50V$, $I_{DS} = 100$ mA
Drain Efficiency	η	45	50	60	%	
Pulse Droop	D	-0.5	-0.2	+0.2	dB	
Input Return Loss	IRL	8	12	20	dB	
Load Mismatch Stability	VSWR-S	2:1				
VSWR Withstand	VSWR-LMT	3:1				

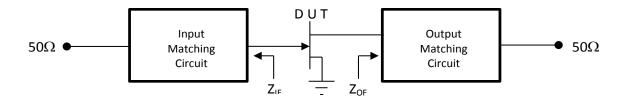
Note: Consult Integra Technologies Application Note 001 for information on how RF output power and pulse droop are measured.

Table 4. Thermal Resistance (Case temperature = 25 °C unless otherwise stated)

Parameter	Symbol	Min	Тур	Max	Units	Test Conditions
Peak Thermal Resistance, Junction to Case	R _{TH(JC)}		0.45		°C/W	$P_{IN}=$ 16W, 50% Efficiency f = 3.1, 3.3, 3.5 GHz 100 μ s pulse length, 10% duty cycle $V_{DS}=$ 50V, $I_{DS}=$ 100mA

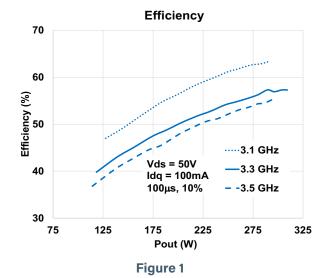
Table 5. Matching Circuit Impedances (Case temperature = 25 °C unless otherwise stated)

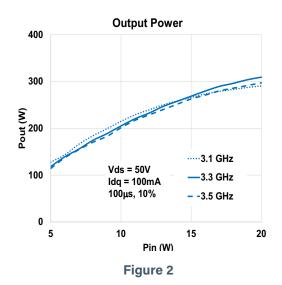
Frequency (GHz)	Z _{IF}	Z _{OF}	Units	Test Conditions
3.1	4.7 - j 11.2	4.6 - j 8.0	Ω	P _{IN} = 16W
3.3	4.2 - j 10.5	4.0 - j 7.7	Ω	100μs Pulse length, 10% Duty Cycle $V_{DS} = 50V, I_{DS} = 100 mA$
3.5	4.0 - j 9.6	3.5 - j 6.5	Ω	

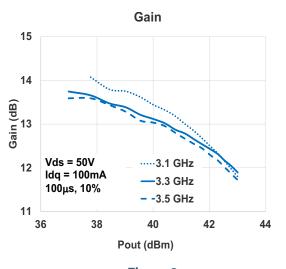




TYPICAL PERFORMANCE







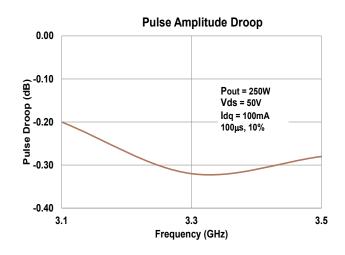


Figure 3

Figure 4

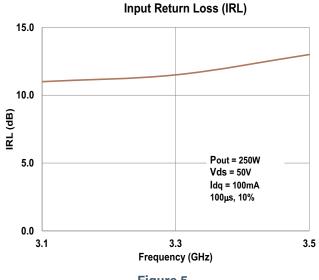
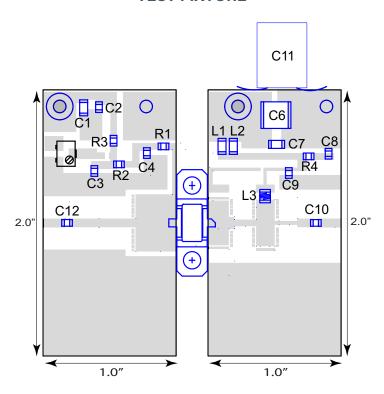


Figure 5

Page 3



TEST FIXTURE

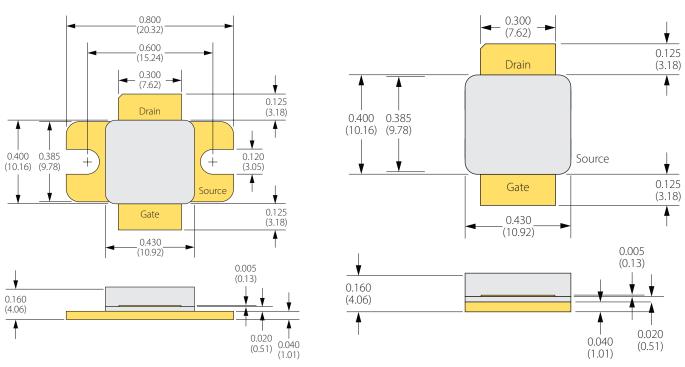


Bill of Materials for IGN3135M250 Test Fixture

Designator	Description	Quantity	Part Number
C1, C7	CAP 1µF, 1206, 100V, X7R	2	GRM31CR72A105KA01L
C2, C3, C8	CAP 0.1μF, 0805, 100V	3	C0805C104K1RAL
C4, C9	CAP 5.6pF, 0805	2	ATC600F5R6CT
C6	CAP 10μF, 2220, X7R, 50V	1	C575X7R1H106M
C10, C12	CAP 12pF, 0805	2	ATC600F120CT
C11	CAP 68μ F , 63V	1	140-XRL63V68
L2, L2	IND FB 33Ω@100MHz, 1206, 6A	2	BLM31PG330S
L3	IND 22nH, 0908	1	0908SQ-22NGL
R1, R2, R4	RES 10Ω, 0805	3	
R3	RES 470Ω, 0805	1	
PC Board	Rogers 30 mils, 1oz/1oz Copper	2	RO4350B-03011



PACKAGE PL44C1



BOLT-DOWN FLANGE OPTION IGN3135M250

EARLESS FLANGE OPTION IGN3135M250S

Dimensions: Inches (mm)



ESD Rating

Parameter	Rating	Standard	
ESD Human Body Model (HBM)	TBD	ESDA/JEDEC JS-001-2012	
ESD Charged Device Model (CDM)	TBD	JEDEC JESD22-C101F	
Moisture Sensitivty Level (MSL)	Unlimited Shelf Life	IPC/JEDEC J-STD-020	

RoHS Compliance

Integra Technologies, Inc declares that its GaN and LDMOS Transistor Products comply with EU Directive 2011/65/EU on the restriction of the use of certain hazardous substances in electrical and electronic equipment (RoHS2), as adopted by EU member states on January 2, 2013 and amended on March 31, 2015 by EU Directive 2015/863/EU.

REACH Compliance

Integra Technologies supports EU Regulation number 1907/2006 concerning the Registration, Evaluation, Authorization, and Restriction of Chemicals (REACH) as these apply to Integra semiconductor products, development tools, and shipping packaging.

In support of the REACH regulation, Integra will:

- •Inform customers and recipients of Integra product if they contain any substances that are of very high concern (SVHC) per the European Chemical Agency (ECHA) website.
- •Notify ECHA if any Integra product that contains any SVHCs which exceed guidelines for REACH chemicals by weight per part number and for total content weight per year for all products produced in or imported to the European market.
- Cease shipments of product containing REACH Annex XIV substances until authorization has been obtained.
- Cease shipment of product containing REACH Annex XVII chemicals when restrictions apply.

Integra has evaluated its materials, BOMs, and product specifications and product and has determined that this transistor conforms to all REACH and SVHC regulations and guidelines. Integra has implemented actions and control programs that will assure continued compliance.

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DEFINITIONS:

DATA SHEET STATUS

Advanced Specification - This data sheet contains Advanced specifications.

Preliminary Specification - This data sheet contains specifications based on preliminary measurements and data.

Final Specification - This data sheet contains final product specifications

MAXIMUM RATINGS Stress above one or more of the maximum ratings may cause permanent damage to the device. These are maximum ratings only operation of the device at these or at any other conditions above those given in the characteristics sections of the specification is not implied. Exposure to maximum values for extended periods of time may affect device reliability.

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